<u>SENSITRON</u> SEMICONDUCTOR

TECHNICAL DATA DATA SHEET 240, REV A

SILICON SCHOTTKY RECTIFIER DIE Ultra Low Reverse Leakage

Applications:

• Switching Power Supply • Converters • Free-Wheeling Diodes • Polarity Protection Diode

Features:

- Ultra low Reverse Leakage Current
- Soft Reverse Recovery at Low and High Temperature2
- Very Low Forward Voltage Drop
- Low Power Loss, High Efficiency
- High Surge Capacity
- Guard Ring for Enhanced Durability and Long Term Reliability
- Guaranteed Reverse Avalanche Characteristics
- Electrically / Mechanically Stable during and after packaging
- Out Performs 100 Volt Ultrafast Rectifiers

Maximum Ratings:

| Characteristics | Symbol | Condition | Max. | Units |
|--|--------------------|---|-------------|-------|
| Peak Inverse Voltage | V _{RWM} | - | - 100 | |
| Max. Average Forward Current | I _{F(AV)} | 50% duty cycle, rectangular 16 wave form | | A |
| Max. Peak One Cycle Non- Repetitive Surge Current | I _{FSM} | 10 ms, Sine pulse ⁽¹⁾ 240 | | A |
| Non-Repetitive Avalanche Energy | E _{AS} | T _J = 25 °C, I _{AS} = 0.6 A, L = 30mH | 0.6 A, 8.8 | |
| Repetitive Avalanche Current | I _{AR} | I_{AS} decay linearly to 0 in 1 μs 0.6 f limited by T _J max V _A =1.5V _R | | A |
| Max. Junction Temperature | TJ | - | -55 to +175 | |
| Max. Storage Temperature | T _{stg} | 55 to +175 | | °C |

Electrical Characteristics:

| Characteristics | Symbol | Condition | Max. | Units |
|---------------------------|-----------------|--|------|-------|
| Max. Forward Voltage Drop | V _{F1} | @ 16A, Pulse, T _J = 25 °C | 0.85 | V |
| | V _{F2} | @ 16A, Pulse, T _J = 125 °C | 0.69 | V |
| Max. Reverse Current | I _{R1} | @V _R = 100V, Pulse, | 10 | μA |
| | | T _J = 25 °C | | |
| | I _{R2} | @V _R = 100V, Pulse, | 1.0 | mA |
| | | T _J = 125 °C | | |
| Max. Junction Capacitance | CT | @V _R = 5V, T _C = 25 °C | 500 | pF |
| | | f _{SIG} = 1MHz, | | |
| | | I _{SIG} = 50mV (p-p) | | |

(1) in SHD package

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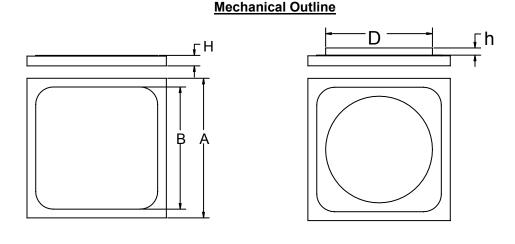


Figure 1

Figure 2

| Α | В | D | Н | h |
|-------------|-------------|-------------------|--------------|-------------|
| 0.125±0.003 | 0.116±0.003 | 0.070 ± 0.005 | 0.0155±0.001 | 0.010±0.002 |

Top side(Anode) metallization: $A = A1 - 25 \text{ k}\text{\AA}$ minimum, Figure 1 $B = Ag - 30 \text{ k}\text{\AA}$ minimum, Figure 1 $C = Au - 12 \text{ k}\text{\AA}$ min, Figure 2

Bottom side (Cathode) metallization: A, B, C = Ti/Ni/Ag - 30 kÅ minimum.

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